

Features

· 200V/1.2A,

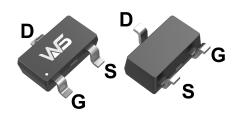
 $R_{DS(ON)} = 850 m\Omega(max.) @ V_{GS} = 10 V$

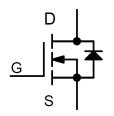
- · ESD Protection
- · 100% UIS + R_g Tested
- · Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Applications

- DC-DC converter for Networking.
- · Load switch.

Pin Configuration





SOT-23-3

Absolute Maximum Ratings (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit						
Common Ratings									
V _{DSS}	Drain-Source Voltage	200	_ v						
V _{GSS}	Gate-Source Voltage	±25							
TJ	Maximum Junction Temperature	150	- °C						
T _{STG}	Storage Temperature Range	-55 to 150							
I _S	Diode Continuous Forward Current	T _A =25°C	1.2	А					
	Continuous Drain Current	T _A =25°C	1.2	A					
I _D		T _A =70°C	0.96						
I _{DM} a	Pulsed Drain Current	T _A =25°C	4.8	А					
P_D	Maximum Power Dissipation	T _A =25°C	2.5	W					
		T _A =70°C	1.6						
R _{0JA} c	Thermal Resistance-Junction to Ambient	t ≤ 10s	50	°C/W					
		Steady State	90	°C/W					
I _{AS} b	Avalanche Current, Single pulse	L=0.5mH	1	А					
E _{AS} b	Avalanche Energy, Single pulse	L=0.5mH	0.25	mJ					

Note a: Pulse width limited by max. junction temperature.

Note b : UIS tested and pulse width limited by maximum junction temperature 150° C (initial temperature $T_j=25^{\circ}$ C).

Note c : Surface mounted on 1in² pad area.



Electrical Characteristics $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

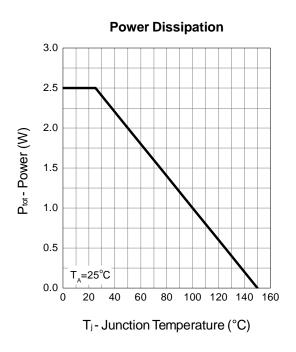
Static Cha	racteristics										
		Static Characteristics									
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	200	-	-	V					
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =160V, V _{GS} =0V	-	-	1	^					
		T _J =85°C	-	-	30	μΑ					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{DS}=250\mu A$	1	2	3	V					
I _{GSS}	Gate Leakage Current	V_{GS} =±25V, V_{DS} =0V	-	-	±10	μΑ					
R _{DS(ON)} d	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =1A	-	680	850	mΩ					
Diode Characteristics											
V _{SD} d	Diode Forward Voltage	I _{SD} =1A, V _{GS} =0V	-	0.8	1.3	V					
t _{rr}	Reverse Recovery Time	I 4A -II /-II 400A/	-	48	-	ns					
Q _{rr}	Reverse Recovery Charge	I_{SD} =1A, dI_{SD}/dt =100A/ μ s	-	70	-	nC					
Dynamic Characteristics ^e											
R_{G}	Gate Resistance	V_{GS} =0V, V_{DS} =0V, f =1MHz	-	4	-	Ω					
C _{iss}	Input Capacitance	V _{GS} =0V,	-	280	-	pF					
C _{oss}	Output Capacitance	V _{DS} =30V,	-	25	-						
C _{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	-	8.5	-						
t _{d(ON)}	Turn-on Delay Time	$\begin{array}{c} V_{DD}{=}30V,R_L{=}30\Omega,\\ I_{DS}{=}1A,V_{GEN}{=}10V,\\ R_G{=}6\Omega \end{array}$	-	10	18	ns					
t _r	Turn-on Rise Time		-	8	15						
t _{d(OFF)}	Turn-off Delay Time		-	9	17						
t _f	Turn-off Fall Time		-	2	4						
Gate Char	Gate Charge Characteristics ^e										
Q_g	Total Gate Charge		-	6	9	nC					
Q_{gs}	Gate-Source Charge	V _{DS} =100V, V _{GS} =10V, I _{DS} =1A	-	2	-						
Q_{gd}	Gate-Drain Charge	105-171	-	1.5	-						

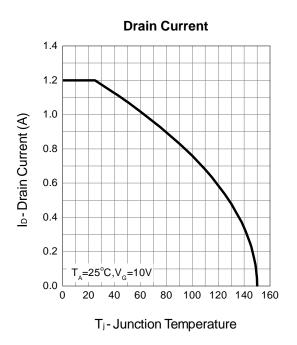
Note d : Pulse test ; pulse width≤300μs, duty cycle≤2%.

Note e: Guaranteed by design, not subject to production testing.



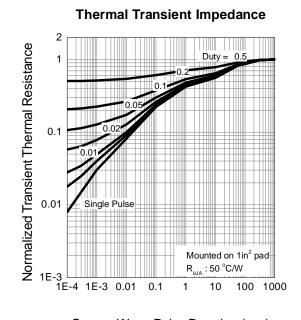
Typical Operating Characteristics





Safe Operation Area 10 (V) tuguing on the state of the

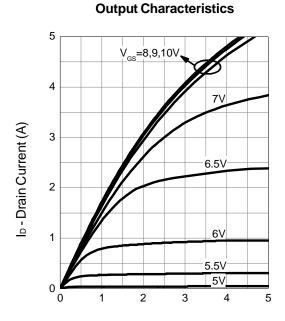
V_{DS} - Drain - Source Voltage (V)



Square Wave Pulse Duration (sec)

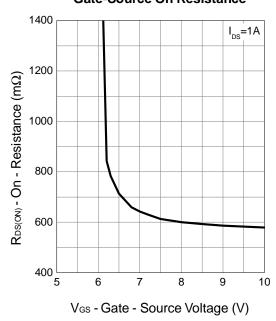


Typical Operating Characteristics (Cont.)

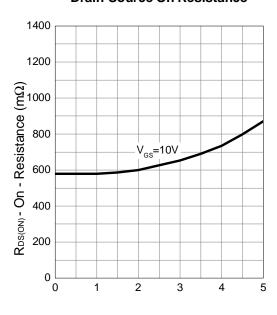


V_{DS} - Drain - Source Voltage (V)

Gate-Source On Resistance

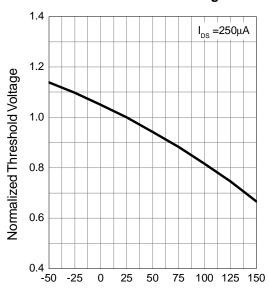


Drain-Source On Resistance



ID-Drain Current (A)

Gate Threshold Voltage

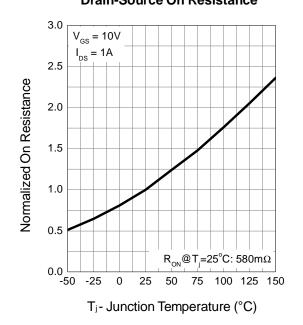


T_j - Junction Temperature (°C)

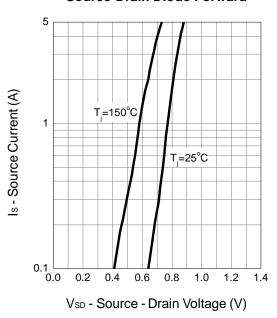


Typical Operating Characteristics (Cont.)

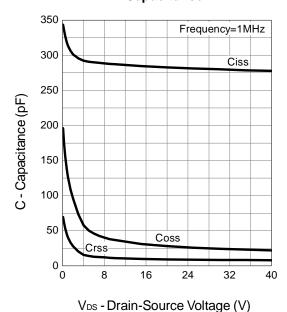
Drain-Source On Resistance



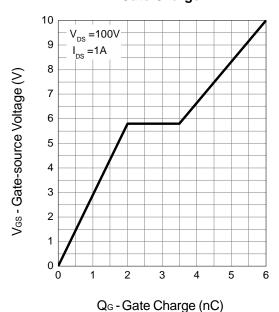
Source-Drain Diode Forward



Capacitance



Gate Charge





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